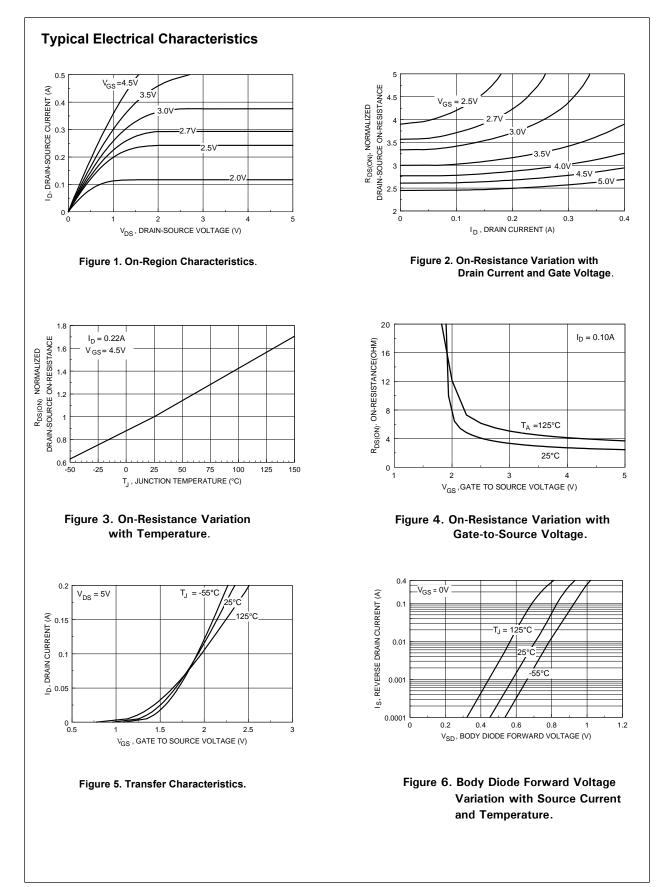
	ICONDUCTOR TM				July 199	
-	6301N N-Channel, Digit	al FET				
Dual N-Channel, Digital FET General Description These dual N-Channel logic level enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for bipolar digital transistors and small			 Features 25 V, 0.22 A continuous, 0.65 A peak. R_{DS(ON)} = 4 Ω @ V_{GS}= 4.5 V, R_{DS(ON)} = 5 Ω @ V_{GS}= 2.7 V. Very low level gate drive requirements allowing direct operation in 3 V circuits (V_{GS(th)} < 1.5 V). Gate-Source Zener for ESD ruggedness 			
signal I	signal MOSFETs.		 Compact industry standard SC70-6 surface mount package. 			
•		8 8 8				
SC7	S2 D1 9	SuperSOT TM -6 D2 S1	[SO-8	SOT-223	
*The pin Units ins	Control of either or of either or of the carrier can be of either or	are interchangeable. entation and will not affect the	functionality of the device.		6 or 3	
*The pin Units ins	Control of the symmetrical; pin 1 and 4	are interchangeable. entation and will not affect the	1 [functionality of the device. wise noted		6 or 3	
*The pin Units ins Absol	SC70-6 outs are symmetrical; pin 1 and 4 side the carrier can be of either ori ute Maximum Ratin	are interchangeable. entation and will not affect the	1 [functionality of the device. wise noted	1 or 4 2 or 5 3 or 6	6 or 3 5 or 2 4 or 1 *	
*The pin Units ins Absol Symbol	SC70-6 SC70-6 uts are symmetrical; pin 1 and 4 side the carrier can be of either ori ute Maximum Ratin Parameter	are interchangeable. entation and will not affect the	1 [functionality of the device. wise noted	I or 4 *	6 or 3 5 or 2 4 or 1 *	
*The pin Units ins Absol Symbol V _{DSS}	SCT0-6 SCT0-6 outs are symmetrical; pin 1 and 4 side the carrier can be of either ori ute Maximum Ratin Parameter Drain-Source Voltage Gate-Source Voltage Drain/Output Current	are interchangeable. entation and will not affect the	1 [functionality of the device. wise noted	TDG6301N 25	6 or 3 5 or 2 4 or 1 *	
*The pin Units ins Absol Symbol V _{DSS} V _{GSS}	SCT0-6 SCT0-6 outs are symmetrical; pin 1 and 4 side the carrier can be of either ori ute Maximum Ratin Parameter Drain-Source Voltage Gate-Source Voltage Drain/Output Current	are interchangeable. entation and will not affect the entation and will not affect the entation $T_A = 25^{\circ}$ C unless other Continuous Pulsed	1 [functionality of the device. wise noted	FDG6301N 25 8 0.22	6 or 3 5 or 2 4 or 1 *	
*The pin Units ins Absol Symbol V _{DSS} V _{OSS} I _D	SC70-6 outs are symmetrical; pin 1 and 4 side the carrier can be of either or ute Maximum Ratin Parameter Drain-Source Voltage Gate-Source Voltage Drain/Output Current	are interchangeable. entation and will not affect the the second	functionality of the device.	FDG6301N 25 8 0.22 0.65	6 or 3 5 or 2 4 or 1 *	
*The pin Units ins Absol Symbol V _{DSS} V _{GSS} I _D P _D	outs are symmetrical; pin 1 and 4 side the carrier can be of either ori ute Maximum Ratin Parameter Drain-Source Voltage Gate-Source Voltage Drain/Output Current	are interchangeable. entation and will not affect the entation an	functionality of the device.	FDG6301N 25 8 0.22 0.65 0.3	6 or 3 5 or 2 4 or 1 *	
*The pin Units ins Absol Symbol V _{DSS} V _{GSS} I _D T _J ,T _{STG} ESD	A strain of the second	are interchangeable. entation and will not affect the entation and entation	functionality of the device.	FDG6301N 25 8 0.22 0.65 0.3 -55 to 150	6 or 3 5 or 2 4 or 1 *	

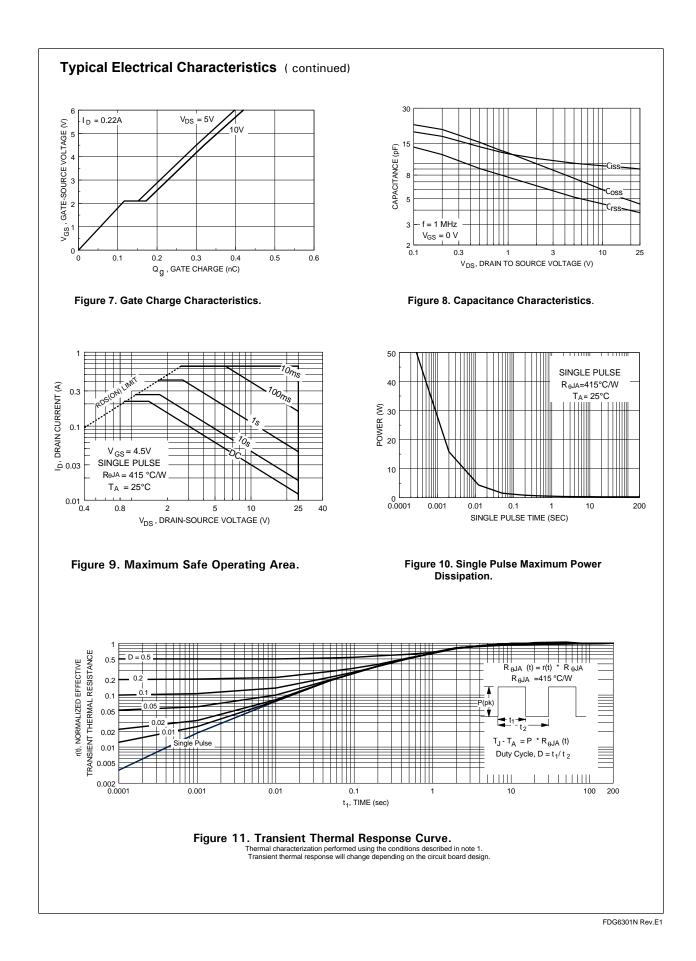
Symbol	Parameter	Conditions	Min	Тур	Max	Units
OFF CHAR	ACTERISTICS					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	25			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	I_{D} = 250 µA, Referenced to 25 °C		25		mV /°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 20 V, V_{GS} = 0 V$			1	μA
		$T_{J} = 55^{\circ}C$			10	μA
I _{GSS}	Gate - Body Leakage Current	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
	CTERISTICS (Note 2)	•		1		
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.65	0.85	1.5	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp.Coefficient	$I_D = 250 \ \mu$ A, Referenced to $25 \ ^{\circ}C$		-2.1		mV /°C
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, I_{D} = 0.22 \text{ A}$		2.6	4	Ω
		T _J =125°C		5.3	7	
		$V_{GS} = 2.7 \text{ V}, I_{D} = 0.19 \text{ A}$		3.7	5	
I _{D(ON)}	On-State Drain Current	$V_{GS} = 4.5 V, V_{DS} = 5 V$	0.22			А
g _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 0.22 A$		0.2		S
DYNAMIC C	HARACTERISTICS					
C _{iss}	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		9.5		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		6		pF
C _{rss}	Reverse Transfer Capacitance			1.3		pF
SWITCHING	CHARACTERISTICS (Note 2)					-
t _{D(on)}	Turn - On Delay Time	$V_{DD} = 5 V, I_{D} = 0.5 A,$		5	10	ns
ţ	Turn - On Rise Time	$V_{GS} = 4.5 \text{ V}, \ \text{R}_{GEN} = 50 \Omega$		4.5	10	ns
t _{D(off)}	Turn - Off Delay Time			4	8	ns
t,	Turn - Off Fall Time			3.2	7	ns
Q _g	Total Gate Charge	$V_{DS} = 5 V$, $I_D = 0.22 A$,		0.29	0.4	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$		0.12		nC
Q _{gd}	Gate-Drain Charge			0.03		nC
DRAIN-SOU	RCE DIODE CHARACTERISTICS AND MAXIMI	UM RATINGS		1		1
I _s	Maximum Continuous Source Current				0.25	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \ V, \ I_{S} = 0.25 \ A \ (Note 2)$		0.8	1.2	V

Notes:

1. R_{pik} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{pik} is guaranteed y design while $R_{y_{0}A}$ is determined by the user's board design. $R_{y_{0}A} = 415^{\circ}$ C/W on minimum pad mounting on FR-4 board in still air. 2. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2.0%.



FDG6301N Rev.E1



TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACExTM CoolFETTM CROSSVOLTTM E²CMOSTM FACTTM FACT Quiet SeriesTM FAST[®] FAST[®] FASTrTM GTOTM HiSeCTM ISOPLANAR[™] MICROWIRE[™] POP[™] PowerTrench[™] QFET[™] QS[™] Quiet Series[™] SuperSOT[™]-3 SuperSOT[™]-6 SuperSOT[™]-8 TinyLogic™ UHC™ VCX™

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.